Memories

- Memories in Verilog
- Memories on the FPGA
- External Memories
  -- SRAM (async, sync)
  -- DRAM
  -- Flash

Memories: a practical primer

- The good news: huge selection of technologies
  - Small & faster vs. large & slower
  - Every year capacities go up and prices go down
  - New kid on the block: high density, fast flash memories
    - Non-volatile, read/write, no moving parts! (robust, efficient)
- The bad news: perennial system bottleneck
  - Latencies (access time) haven't kept pace with cycle times
  - Separate technology from logic, so must communicate between silicon, so physical limitations (# of pins, R's and C's and L's) limit bandwidths
    - New hopes: capacitive interconnect, 3D IC's
  - Likely the limiting factor in cost & performance of many digital systems: designers spend a lot of time figuring out how to keep memories running at peak bandwidth
  - "It's the memory, stupid"

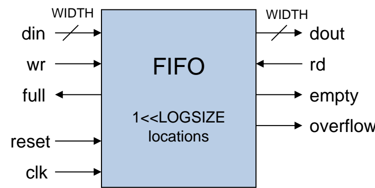
Memories in Verilog

```
• reg bit;  // a single register
• reg [31:0] word;   // a 32-bit register
• reg [31:0] array[15:0];  // 16 32-bit regs
• reg [31:0] array_2d[31:0][15:0];
     // 2 dimensional 32-bit array

• wire [31:0] read_data,write_data;
  wire [3:0] index;

  // combinational (asynch) read
  assign read_data = array[index];

  // clocked (synchronous) write
  always @(posedge clock)
      array[index] <= write_data;
```


Multi-port Memories (aka regfiles)

```
reg [31:0] regfile[30:0]; // 31 32-bit words

// Beta register file: 2 read ports, 1 write
wire [4:0] ra1,ra2,wa;
wire [31:0] rd1,rd2,wd;

assign ra1 = inst[20:16];
assign ra2 = ra2sel ? inst[25:21] : inst[15:11];
assign wa = wasel ? 5'd30 : inst[25:21];

// read ports
assign rd1 = (ra1 == 5'd31) ? 32'd0 : regfile[ra1];
assign rd2 = (ra2 == 5'd31) ? 32'd0 : regfile[ra2];
// write port
always @(posedge clk)
  if (werf) regfile[wa] <= wd;

assign z = ~| rd1;   // used in BEQ/BNE instructions
```

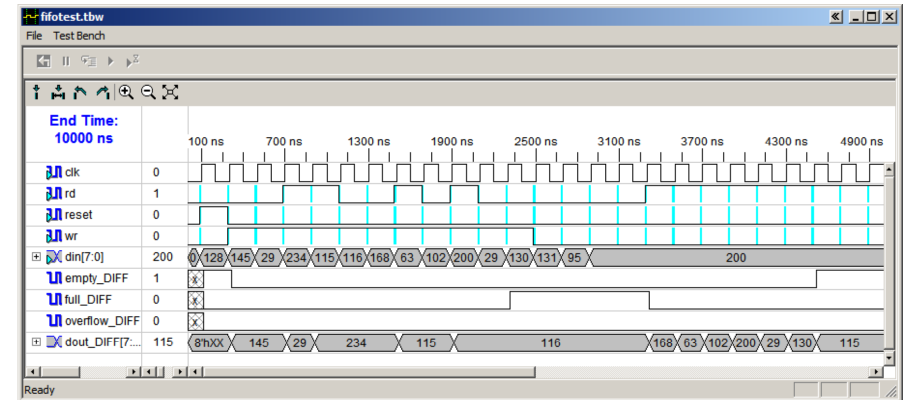
FIFOs




```
// a simple synchronous FIFO (first-in first-out) buffer
// Parameters:
//    LOGSIZE  (parameter) FIFO has 1<<LOGSIZE elements
//    WIDTH    (parameter) each element has WIDTH bits
// Ports:
//    clk      (input) all actions triggered on rising edge
//    reset    (input) synchronously empties fifo
//    din      (input, WIDTH bits) data to be stored
//    wr       (input) when asserted, store new data
//    full     (output) asserted when FIFO is full
//    dout     (output, WIDTH bits) data read from FIFO
//    rd       (input) when asserted, removes first element
//    empty    (output) asserted when fifo is empty
//    overflow (output) asserted when WR but no room, cleared on next RD

module fifo #(parameter LOGSIZE = 2,   // default size is 4 elements
                        WIDTH = 4)     // default width is 4 bits
              (input clk,reset,wr,rd, input [WIDTH-1:0] din,
               output full,empty,overflow, output [WIDTH-1:0] dout);
…
endmodule
```


FIFOs in action

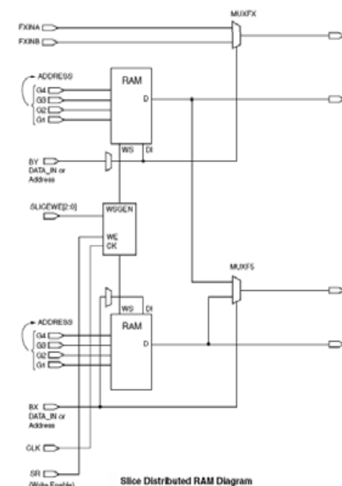
```
// make a fifo with 8 8-bit locations
fifo f8x8 #(.LOGSIZE(3),.WIDTH(8))
           (.clk(clk),.reset(reset),
            .wr(wr),.din(din),.full(full),
            .rd(rd),.dout(dout),.empty(empty),
            .overflow(overflow));
```



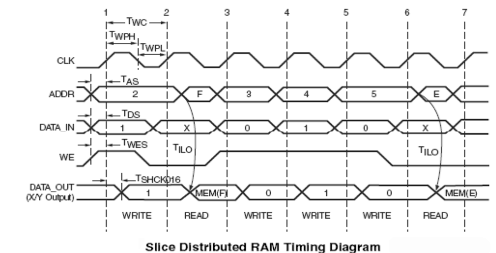
FPGA memory implementation

- Regular registers in logic blocks
  - Piggy use of resources, but convenient & fast if small
- [Xilinx Vertex II] use the LUTs:
  - Single port: 16x(1,2,4,8), 32x(1,2,4,8), 64x(1,2), 128x1
  - Dual port (1 R/W, 1R): 16x1, 32x1, 64x1
  - Can fake extra read ports by cloning memory: all clones are written with the same addr/data, but each clone can have a different read address
- [Xilinx Vertex II] use block ram:
  - 18K bits: 16Kx1, 8Kx2, 4Kx4 with parity: 2Kx(8+1), 1Kx(16+2), 512x(32+4)
  - Single or dual port
  - Pipelined (clocked) operations
  - Labkit XCV2V6000: 144 BRAMs, 2952K bits total

LUT-based RAMs



Slice Distributed RAM Diagram

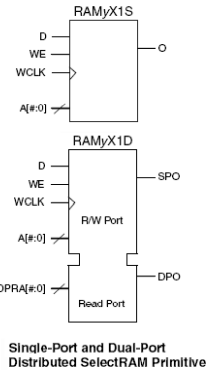


Slice Distributed RAM Timing Diagram

CLB Distributed RAM Switching Characteristics

Description	Symbol	Speed Grade -6	Speed Grade -5	Speed Grade -4	Units
Sequential Delays					
Clock CLK to X/Y outputs (WE active) in 16 x 1 mode	$T_{SHCKO16}$	1.63	1.79	2.05	ns, Max
Clock CLK to X/Y outputs (WE active) in 32 x 1 mode	$T_{SHCKO32}$	1.97	2.17	2.49	ns, Max
Clock CLK to F5 output	$T_{SHCKOF5}$	1.77	1.94	2.23	ns, Max
Setup and Hold Times Before/After Clock CLK					
BX/BY data inputs (DIN)	T_{DS}/T_{DH}	0.53/–0.09	0.58/–0.10	0.67/–0.11	ns, Min
F/G address inputs	T_{AS}/T_{AH}	0.40/ 0.00	0.44/ 0.00	0.50/ 0.00	ns, Min
SR input (WS)	T_{WES}/T_{WEH}	0.42/–0.01	0.46/–0.01	0.53/–0.01	ns, Min
Clock CLK					
Minimum Pulse Width, High	T_{WPH}	0.57	0.63	0.72	ns, Min
Minimum Pulse Width, Low	T_{WPL}	0.57	0.63	0.72	ns, Min
Minimum clock period to meet address write cycle time	T_{WC}	1.14	1.25	1.44	ns, Min
Combinatorial Delays					
4-input function: F/G inputs to X/Y outputs	T_{ILO}	0.35	0.39	0.44	ns, Max

LUT-based RAM Modules



Single-Port and Dual-Port Distributed SelectRAM Primitive

Single-Port and Dual-Port Distributed SelectRAM

Primitive	RAM Size	Type	Address Inputs
RAM16X1S	16 bits	single-port	A3, A2, A1, A0
RAM32X1S	32 bits	single-port	A4, A3, A2, A1, A0
RAM64X1S	64 bits	single-port	A5, A4, A3, A2, A1, A0
RAM128X1S	128 bits	single-port	A6, A5, A4, A3, A2, A1, A0
RAM16X1D	16 bits	dual-port	A3, A2, A1, A0
RAM32X1D	32 bits	dual-port	A4, A3, A2, A1, A0
RAM64X1D	64 bits	dual-port	A5, A4, A3, A2, A1, A0

Wider Library Primitives

Primitive	RAM Size	Data Inputs	Address Inputs	Data Outputs
RAM16x2S	16 x 2-bit	D1, D0	A3, A2, A1, A0	O1, O0
RAM32X2S	32 x 2-bit	D1, D0	A4, A3, A2, A1, A0	O1, O0
RAM64X2S	64 x 2-bit	D1, D0	A5, A4, A3, A2, A1, A0	O1, O0
RAM16X4S	16 x 4-bit	D3, D2, D1, D0	A3, A2, A1, A0	O3, O2, O1, O0
RAM32X4S	32 x 4-bit	D3, D2, D1, D0	A4,A3, A2, A1, A0	O3, O2, O1, O0
RAM16X8S	16 x 8-bit	D <7:0>	A3, A2, A1, A0	O <7:0>
RAM32X8S	32 x 8-bit	D <7:0>	A4,A3, A2, A1, A0	O <7:0>

```
// instantiate a LUT-based RAM module
RAM16X1S mymem #(.INIT(16'b0110_1111_0011_0101_1100))  // msb first
            (.D(din),.O(dout),.WE(we),.WCLK(clock_27mhz),
             .A0(a[0]),.A1(a[1]),.A2(a[2]),.A3(a[3]));
```

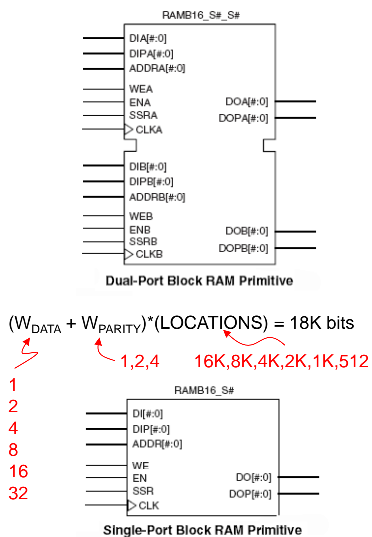

Tools will often build these for you…

From Lab 2:

```
reg [7:0] segments;
always @ (switch[3:0]) begin
  case (switch[3:0])
  4'h0: segments[6:0] = 7'b0111111;
  4'h1: segments[6:0] = 7'b0000110;
  4'h2: segments[6:0] = 7'b1011011;
  4'h3: segments[6:0] = 7'b1001111;
  4'h4: segments[6:0] = 7'b1100110;
  4'h5: segments[6:0] = 7'b1101101;
  4'h6: segments[6:0] = 7'b1111101;
  4'h7: segments[6:0] = 7'b0000111;
  4'h8: segments[6:0] = 7'b1111111;
  4'h9: segments[6:0] = 7'b1100111;
  4'hA: segments[6:0] = 7'b1110111;
  4'hB: segments[6:0] = 7'b1111100;
  4'hC: segments[6:0] = 7'b1011000;
  4'hD: segments[6:0] = 7'b1011110;
  4'hE: segments[6:0] = 7'b1111001;
  4'hF: segments[6:0] = 7'b1110001;
  default: segments[6:0] = 7'b00000000;
  endcase
  segments[7] = 1'b0;  // decimal point
end
```

```
=============================================
*            HDL Synthesis                  *
=============================================

Synthesizing Unit <lab2_2>.
    Related source file is "../lab2_2.v".
    ...
    Found 16x7-bit ROM for signal <$n0000>.
    ...
    Summary:
      inferred   1 ROM(s).
        ...
Unit <lab2_2> synthesized.

=============================================
Timing constraint: Default path analysis
Total number of paths / destination ports: 28 / 7
-------------------------------------------------
Delay:               7.244ns (Levels of Logic = 3)
Source:              switch<3> (PAD)
Destination:         user1<0> (PAD)

Data Path: switch<3> to user1<0>
                          Gate     Net
Cell:in->out   fanout   Delay    Delay  Logical Name
----------------------------------------  ------------
IBUF:I->O          7    0.825    1.102  switch_3_IBUF
LUT4:I0->O         1    0.439    0.517  Mrom__n0000_inst_lut4_01
OBUF:I->O               4.361           user1_0_OBUF
----------------------------------------
Total                   7.244ns (5.625ns logic, 1.619ns route)
                                (77.7% logic, 22.3% route)
```


Block Memories (BRAMs)



Dual-Port Block RAM Primitive

$(W_{DATA} + W_{PARITY})$*(LOCATIONS) = 18K bits

1,2,4 16K,8K,4K,2K,1K,512

1
2
4
8
16
32

Single-Port Block RAM Primitive

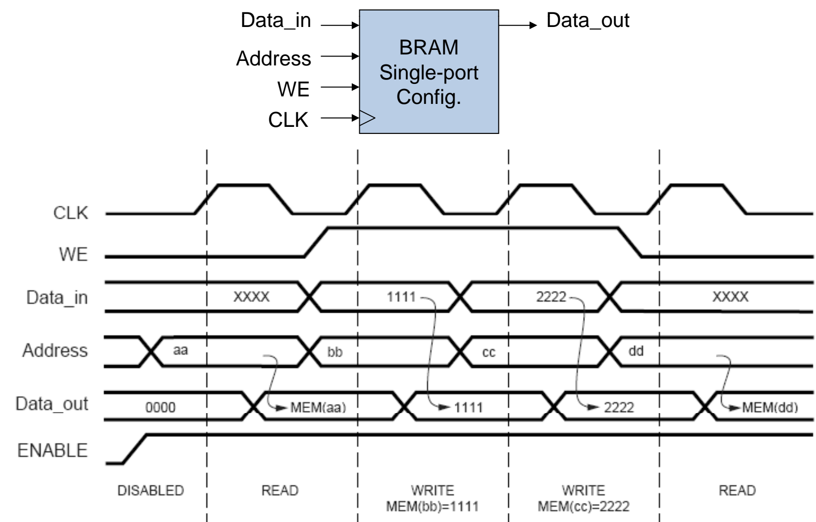
Dual-Port Block RAM Primitives

Primitive	Port A Width	Port B Width
RAMB16_S1_S1	1	1
RAMB16_S1_S2		2
RAMB16_S1_S4		4
RAMB16_S1_S9		(8+1)
RAMB16_S1_S18		(16+2)
RAMB16_S1_S36		(32+4)
RAMB16_S2_S2	2	2
RAMB16_S2_S4		4
RAMB16_S2_S9		(8+1)
RAMB16_S2_S18		(16+2)
RAMB16_S2_S36		(32+4)
RAMB16_S4_S4	4	4
RAMB16_S4_S9		(8+1)
RAMB16_S4_S18		(16+2)
RAMB16_S4_S36		(32+4)
RAMB16_S9_S9	(8+1)	(8+1)
RAMB16_S9_S18		(16+2)
RAMB16_S9_S36		(32+4)
RAMB16_S18_S18	(16+2)	(16+2)
RAMB16_S18_S36		(32+4)
RAMB16_S36_S36	(32+4)	(32+4)

Single-Port Block RAM Primitives

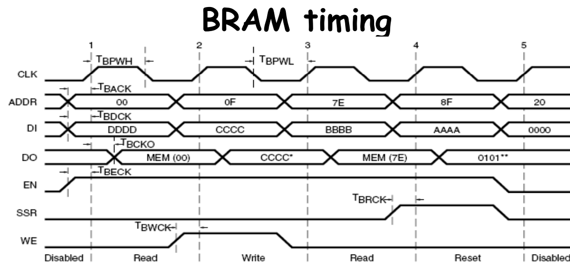
Primitive	Port Width
RAMB16_S1	1
RAMB16_S2	2
RAMB16_S4	4
RAMB16_S9	(8+1)
RAMB16_S18	(16+2)
RAMB16_S36	(32+4)

BRAM Operation



Source: Xilinx App Note 463

BRAM timing



* Write Mode = "WRITE_FIRST"
** SRVAL = 0101

Block SelectRAM Timing Diagram

Block SelectRAM Switching Characteristics

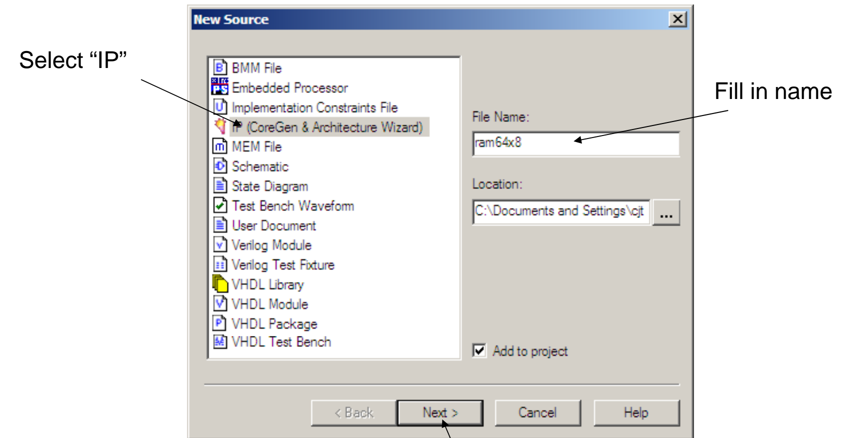
Description	Symbol	Speed Grade -6	Speed Grade -5	Speed Grade -4	Units
Sequential Delays					
Clock CLK to DOUT output	T_{BCKO}	2.10	2.31	2.65	ns, Max
Setup and Hold Times Before Clock CLK					
ADDR inputs	T_{BACK}/T_{BCKA}	0.29/ 0.00	0.32/ 0.00	0.36/ 0.00	ns, Min
DIN inputs	T_{BDCK}/T_{BCKD}	0.29/ 0.00	0.32/ 0.00	0.36/ 0.00	ns, Min
EN input	T_{BECK}/T_{BCKE}	0.95/–0.46	1.04/–0.50	1.20/–0.58	ns, Min
RST input	T_{BRCK}/T_{BCKR}	1.31/–0.71	1.44/–0.78	1.65/–0.90	ns, Min
WEN input	T_{BWCK}/T_{BCKW}	0.57/–0.19	0.63/–0.21	0.72/–0.25	ns, Min
Clock CLK					
CLKA to CLKB setup time for different ports	T_{BCCS}	1.0	1.0	1.0	ns, min
Minimum Pulse Width, High	T_{BPWH}	1.17	1.29	1.48	ns, Min
Minimum Pulse Width, Low	T_{BPWL}	1.17	1.29	1.48	ns, Min

Using BRAMs (eg, a 64Kx8 ram)

- From menus: Project → New Source…

Select "IP"

Fill in name

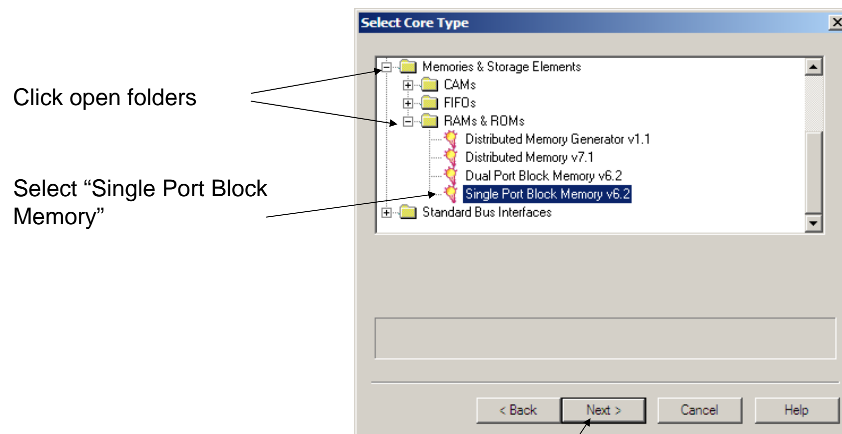


Click "Next" when done…

BRAM Example

Click open folders

Select "Single Port Block Memory"



Click "Next" and then "Finish" on next window

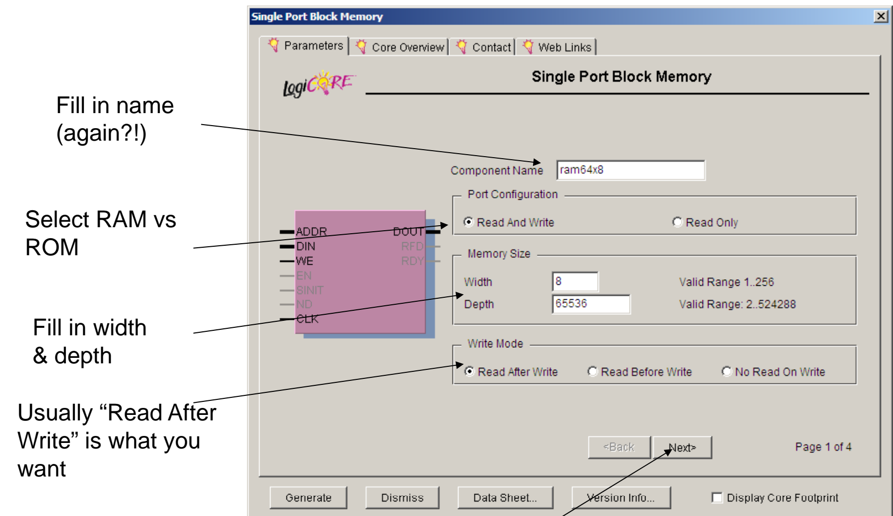
BRAM Example

Fill in name (again?!)

Select RAM vs ROM

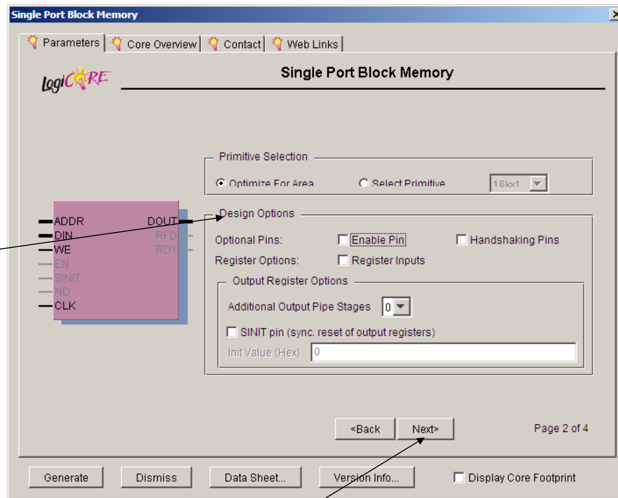
Fill in width & depth

Usually "Read After Write" is what you want



Click "Next" …

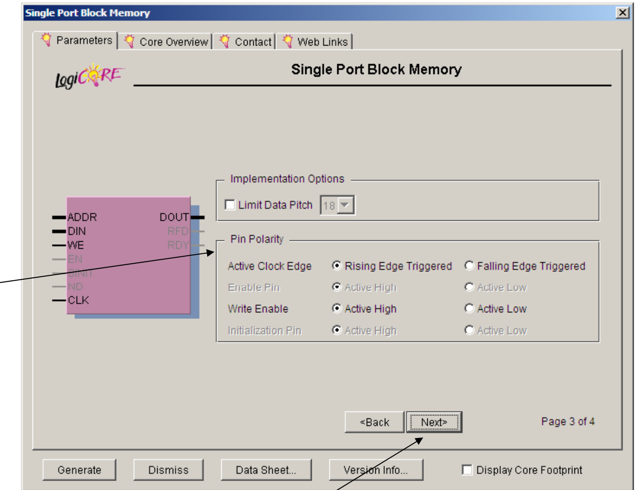
BRAM Example



Can add extra control pins, but usually not

Click “Next” …

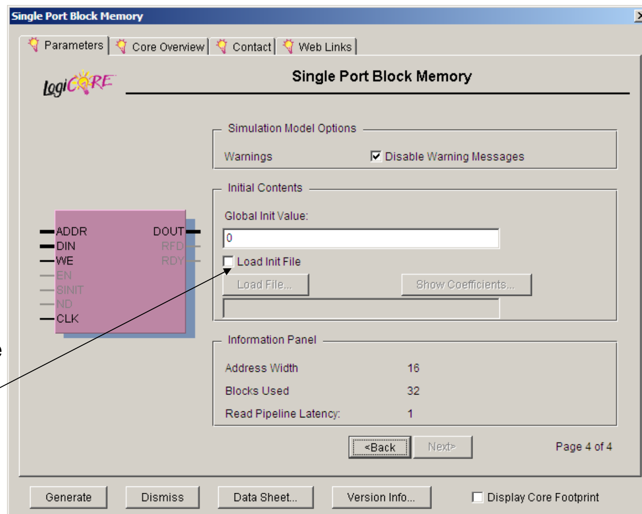
BRAM Example



Select polarity of control pins; active high default is usually just fine

Click “Next” …

BRAM Example



Click to name a .coe file that specifies initial contents (eg, for a ROM)

Click “Generate” to complete

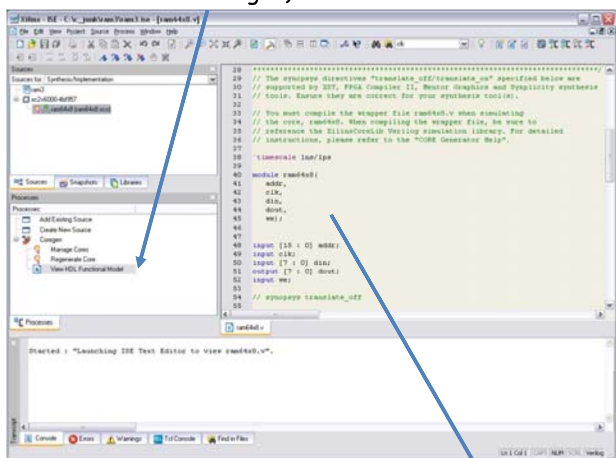
.coe file format

```
memory_initialization_radix=2;
memory_initialization_vector=

00000000,
00111110,
01100011,
00000011,
00000011,
00011110,
00000011,
00000011,
01100011,
00111110,
00000000,
00000000,
```

Memory contents with location 0 first, then location 1, etc. You can specify input radix, in this example we're using binary. MSB is on the left, LSB on the right. Unspecified locations (if memory has more locations than given in .coe file) are set to 0.

Using result in your Verilog

- Look at generated Verilog for module defintion (click on "View HDL Functional Model" under Coregen):



- Use to instantiate instances in your code:

```
ram64x8 foo(.addr(addr),.clk(clk),.we(we),.din(din),.dout(dout));
```


Memory Classification & Metrics

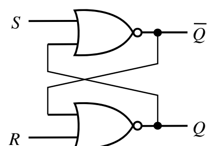
Read-Write Memory		Non-Volatile Read-Write Memory	Read-Only Memory
Random Access	Sequential Access		
SRAM DRAM	FIFO	EPROM E^2PROM FLASH	Mask-Programmed ROM

Key Design Metrics:

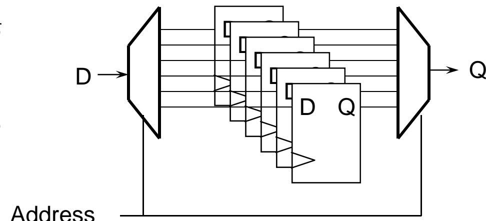
1. Memory Density (number of bits/mm^2) and Size
2. Access Time (time to read or write) and Throughput
3. Power Dissipation

Static RAMs: Latch Based Memory

Set Reset Flip Flop



Register Memory

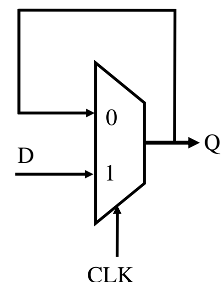


- Works fine for small memory blocks (e.g., small register files)
- Inefficient in area for large memories
- Density is the key metric in large memory circuits

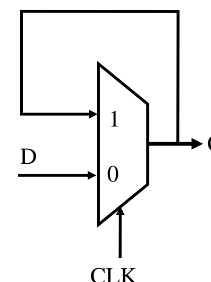
How do we minimize cell size?

Latch and Register Based Memory

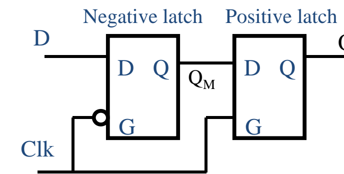
Positive Latch



Negative Latch



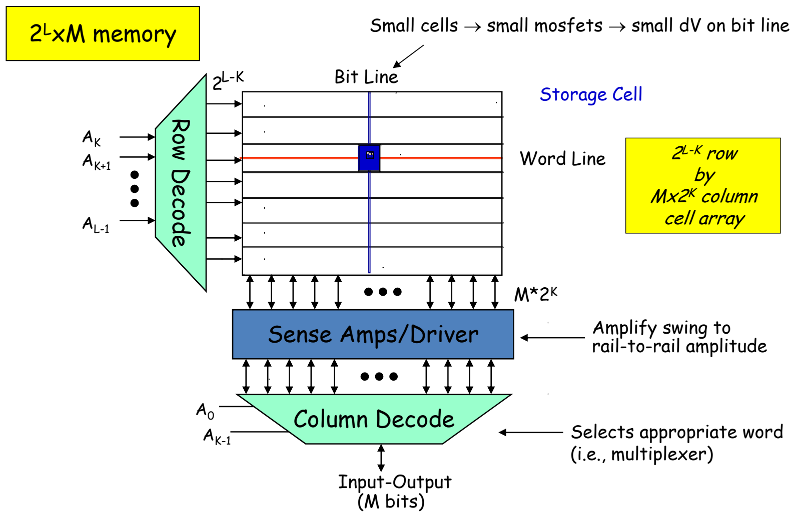
Register Memory



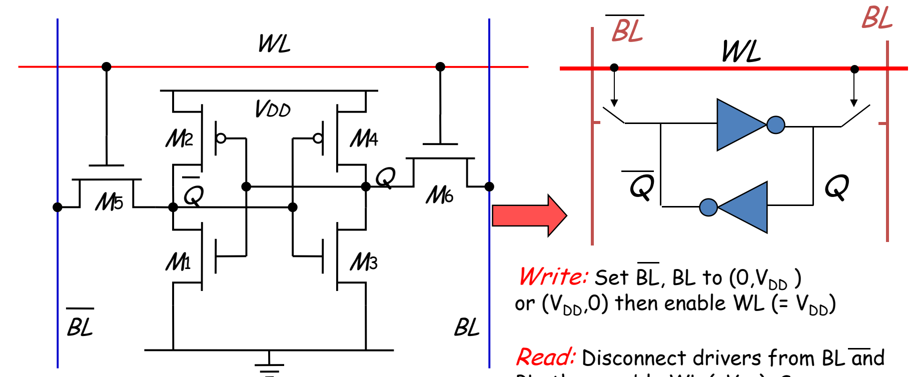
- Alternative view

How do we minimize cell size?

Memory Array Architecture



Static RAM (SRAM) Cell (The 6-T Cell)

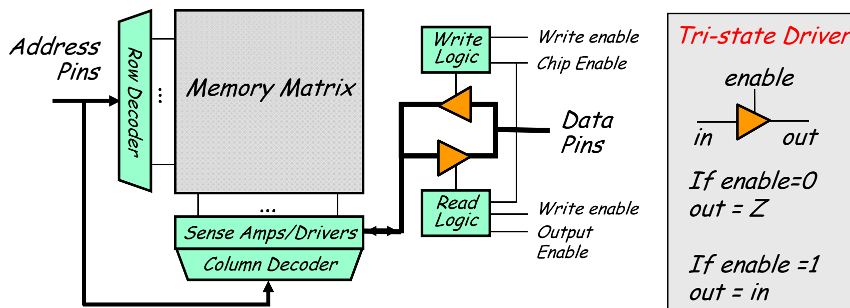


Write: Set $\overline{BL}$, BL to (0,V_{DD}) or (V_{DD},0) then enable WL (= V_{DD})

Read: Disconnect drivers from BL and $\overline{BL}$, then enable WL (=V_{DD}). Sense a small change in BL or $\overline{BL}$

- State held by cross-coupled inverters (M1-M4)
- Retains state as long as power supply turned on
- Feedback must be overdriven to write into the memory

Using External Memory Devices

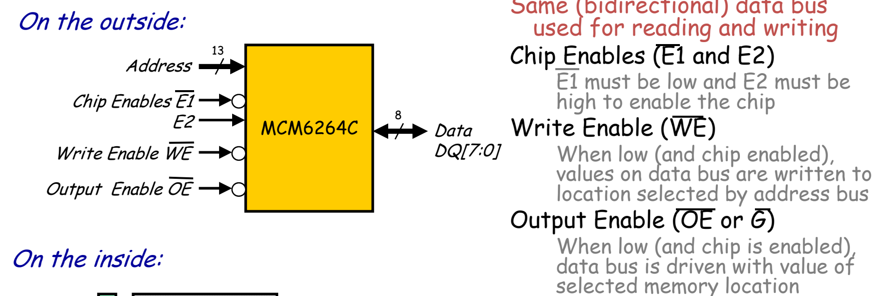


- Address pins drive row and column decoders
- Data pins are bidirectional: shared by reads and writes

Concept of "Data Bus"

- Output Enable gates the chip's tristate driver
- Write Enable sets the memory's read/write mode
- Chip Enable/Chip Select acts as a "master switch"

MCM6264C 8K x 8 Static RAM



Same (bidirectional) data bus used for reading and writing

Chip Enables ($\overline{E1}$ and E2)

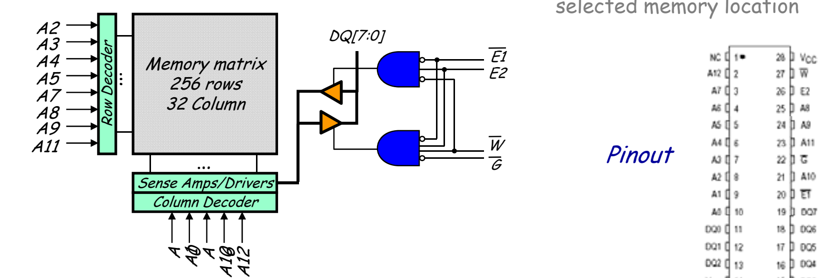
$\overline{E1}$ must be low and E2 must be high to enable the chip

Write Enable ($\overline{WE}$)

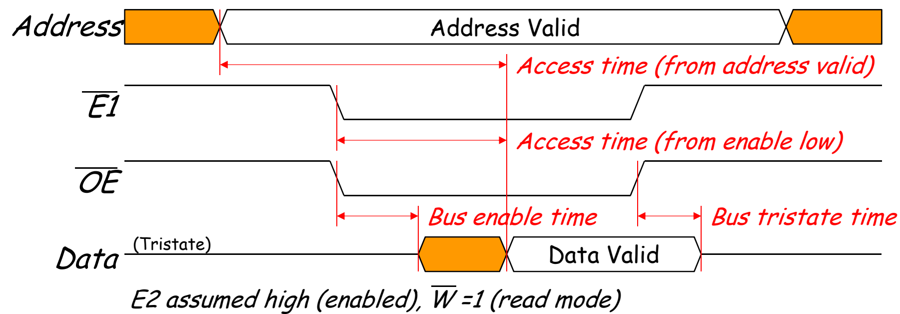
When low (and chip enabled), values on data bus are written to location selected by address bus

Output Enable ($\overline{OE}$ or $\overline{G}$)

When low (and chip is enabled), data bus is driven with value of selected memory location

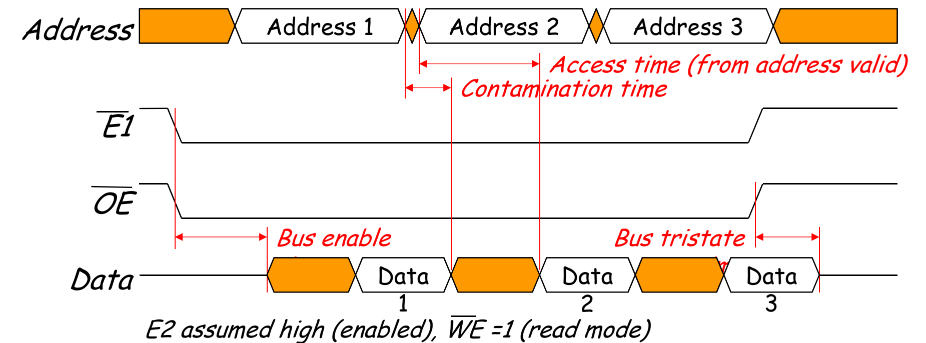


Reading an Asynchronous SRAM



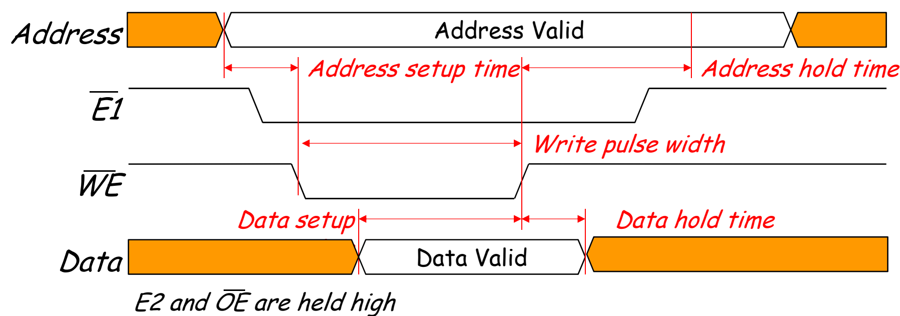
- Read cycle begins when all enable signals (E1, E2, OE) are active
- Data is valid after read access time
  - Access time is indicated by full part number: *MCM6264CP-12 → 12ns*
- Data bus is tristated shortly after OE or E1 goes high

Address Controlled Reads



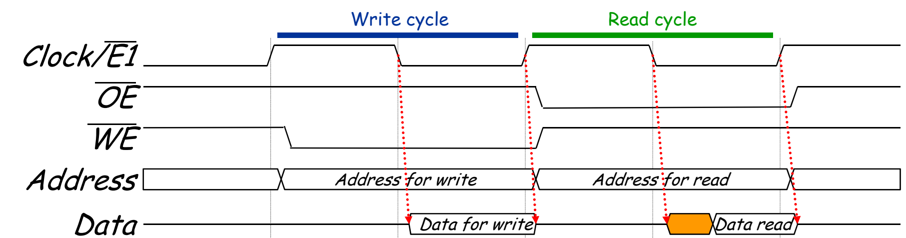
- Can perform multiple reads without disabling chip
- Data bus follows address bus, after some delay

Writing to Asynchronous SRAM



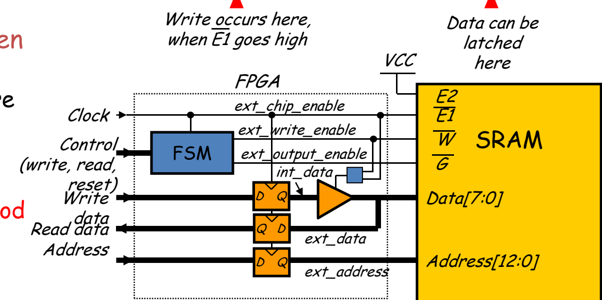
- Data latched when WE or E1 goes high (or E2 goes low)
  - Data must be stable at this time
  - Address must be stable before WE goes low
- Write waveforms are more important than read waveforms
  - Glitches to address can cause writes to random addresses!

Sample Memory Interface Logic

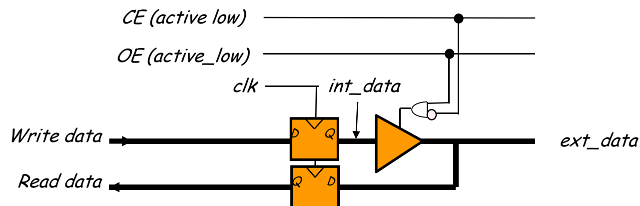


Drive data bus only when clock is low

- Ensures address are stable for writes
- Prevents bus contention
- Minimum clock period is twice memory access time



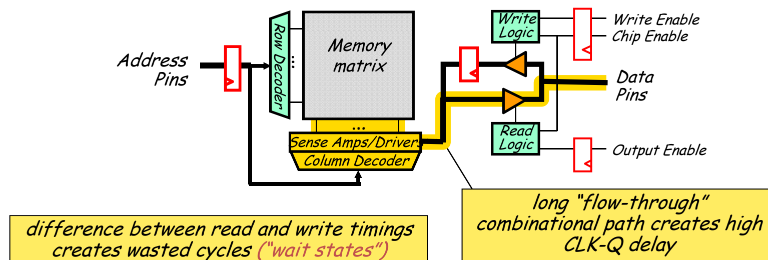
Tristate Data Buses in Verilog

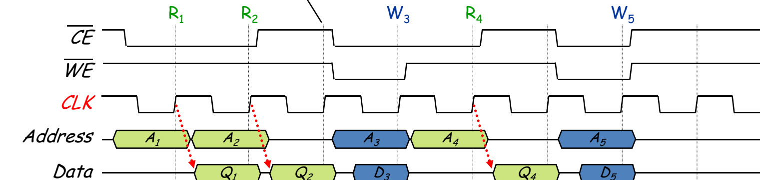



```
output CE,OE;  // these signals are active low
inout [7:0] ext_data;
reg [7:0] read_data,int_data
wire [7:0] write_data;

always @(posedge clk) begin
  int_data <= write_data;
  read_data <= ext_data;
end

// Use a tristate driver to set ext_data to a value
assign ext_data = (~CE & OE) ? int_data : 8'hZZ;
```


Synchronous SRAM Memories

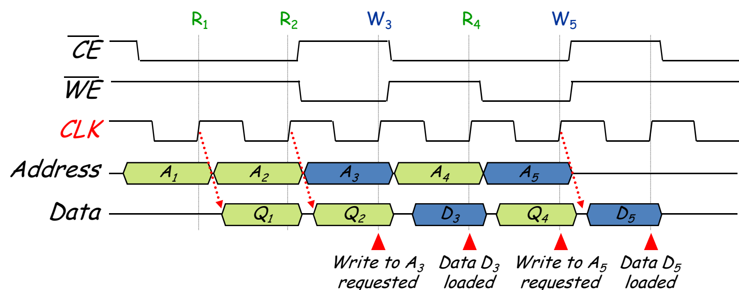
- Clocking provides input synchronization and encourages more reliable operation at high speeds





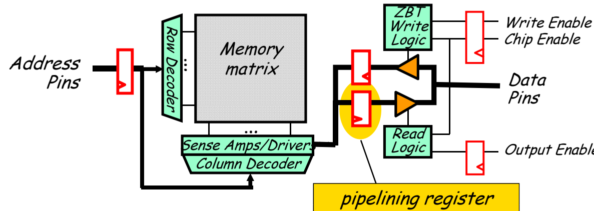
ZBT Eliminates the Wait State

- The wait state occurs because:
  - On a read, data is available *after* the clock edge
  - On a write, data is set up *before* the clock edge
- ZBT ("zero bus turnaround") memories change the rules for writes
  - On a write, data is set up after the clock edge (so that it is read on the following edge)
  - Result: no wait states, higher memory throughput

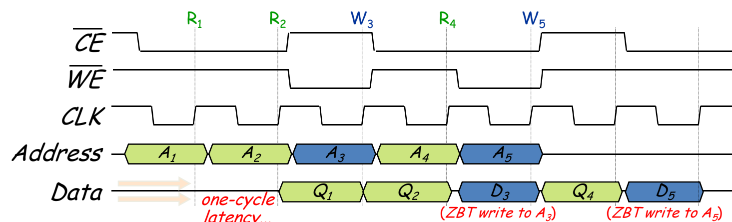


Pipelining Allows Faster CLK

- Pipeline the memory by registering its output
  - Good: Greatly reduces CLK-Q delay, allows higher clock (more throughput)
  - Bad: Introduces an extra cycle before data is available (more latency)



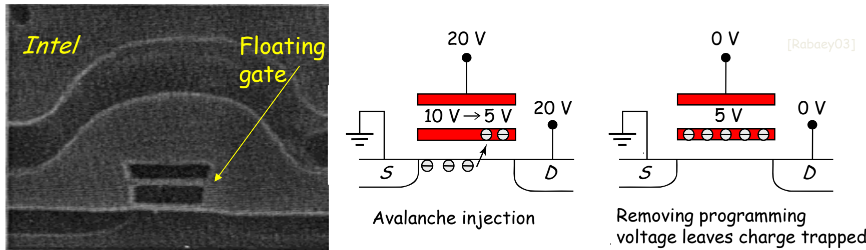
As an example, see the CY7C147X ZBT Synchronous SRAM



EEPROM

Electrically Erasable Programmable Read-Only Memory

EEPROM – The Floating Gate Transistor



Avalanche injection

Removing programming voltage leaves charge trapped

This is a non-volatile memory (retains state when supply turned off)

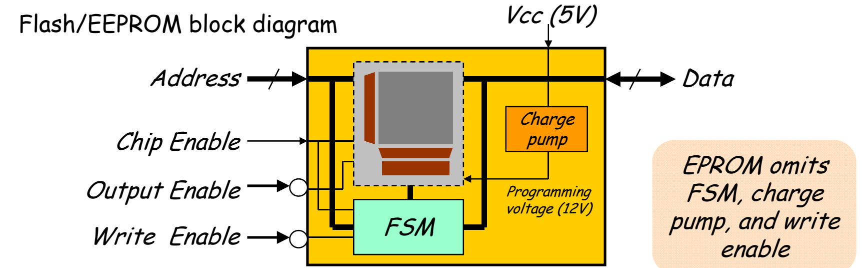
Usage: Just like SRAM, but writes are much slower than reads
(write sequence is controlled by an FSM internal to chip)

Common application: configuration data (serial EEPROM)

Interacting with Flash and (E)EPROM

- Reading from flash or (E)EPROM is the same as reading from SRAM
- Vpp: input for programming voltage (12V)
  - EPROM: Vpp is supplied by programming machine
  - Modern flash/EEPROM devices generate 12V using an on-chip charge pump
- EPROM lacks a write enable
  - Not in-system programmable (must use a special programming machine)
- For flash and EEPROM, write sequence is controlled by an internal FSM
  - Writes to device are used to send signals to the FSM
  - Although the same signals are used, one can't write to flash/EEPROM in the same manner as SRAM

Flash/EEPROM block diagram

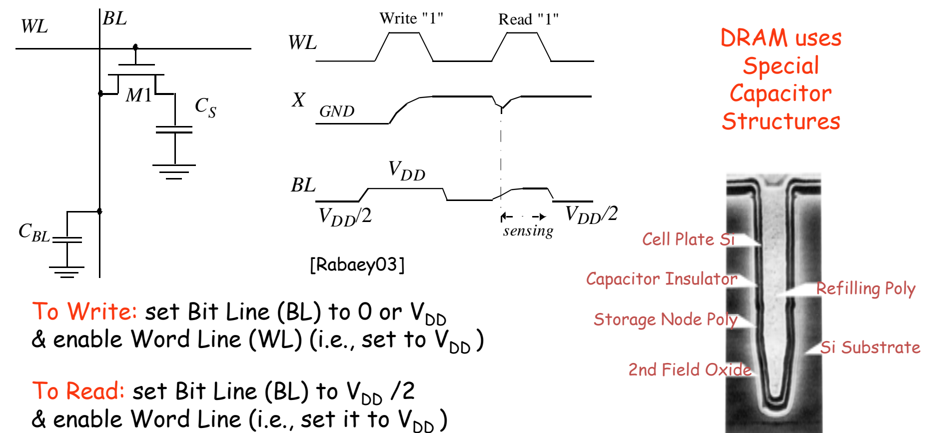


Flash Memory – Nitty Gritty

- Flash memory uses NOR or NAND flash.
  - NAND cells connected in series like resembling NAND gate.
  - NAND requires 60% of the area compared to NOR. NAND used in flash drives.
  - Endurance: 100,000 – 300,000 p/e cycles
  - Life cycle extended through wear -leveling: mapping of physical blocks changes over time.
- Flash memory limitations
  - Can be read or written byte a time
  - Can only be erased block at a time
  - Erasure sets bits to 1.
  - Location can be re-written if the new bit is zero.
- Labkit has 128Mbits of memory in 1Mbit blocks.
  - 3 Volt Intel StrataFlash® Memory (28F128J3A)
  - 100,000 min erase cycle per block
  - Block erasures takes one second
  - 15 minutes to write entire flash ROM

http://www.embeddedintel.com/special_features.php?article=124

Dynamic RAM (DRAM) Cell

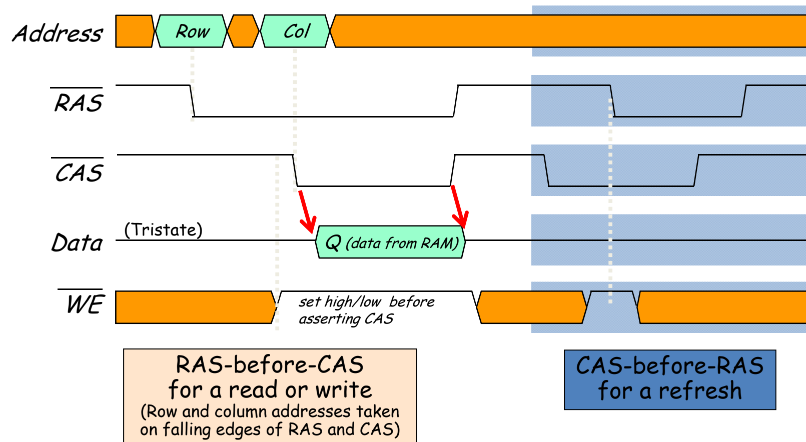


To Write: set Bit Line (BL) to 0 or V_{DD} & enable Word Line (WL) (i.e., set to V_{DD})

To Read: set Bit Line (BL) to V_{DD} /2 & enable Word Line (i.e., set it to V_{DD})

- DRAM relies on charge stored in a capacitor to hold state
- Found in all high density memories (one bit/transistor)
- Must be "refreshed" or state will be lost – high overhead

Asynchronous DRAM Operation



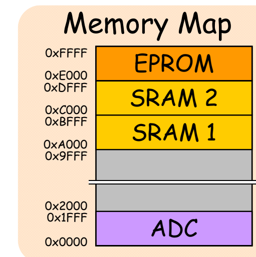
RAS-before-CAS for a read or write
(Row and column addresses taken on falling edges of RAS and CAS)

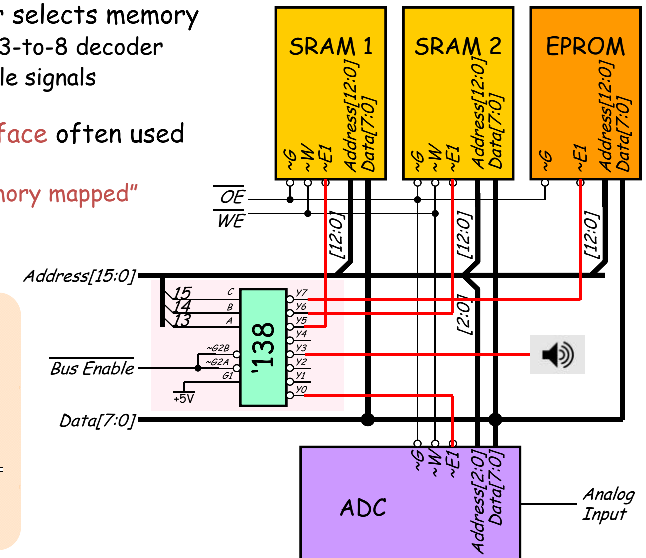
CAS-before-RAS for a refresh

- Clever manipulation of RAS and CAS after reads/writes provide more efficient modes: early-write, read-write, hidden-refresh, etc. (See datasheets for details)

Addressing with Memory Maps

- Address decoder selects memory
  - Example: '138 3-to-8 decoder
  - Produces enable signals
- SRAM-like interface often used for peripherals
  - Known as "memory mapped" peripherals





Memory Devices: Helpful Knowledge

- SRAM vs. DRAM
  - SRAM holds state as long as power supply is turned on. DRAM must be "refreshed" – results in more complicated control
  - DRAM has much higher density, but requires special capacitor technology.
  - FPGA usually implemented in a standard digital process technology and uses SRAM technology
- Non-Volatile Memory
  - Fast Read, but very slow write (EPROM must be removed from the system for programming!)
  - Holds state even if the power supply is turned off
- Memory Internals
  - Has quite a bit of analog circuits internally -- pay particular attention to noise and PCB board integration
- Device details
  - Don't worry about them, wait until 6.012 or 6.374

You Should Understand Why…

- control signals such as *Write Enable* should be registered
- a multi-cycle read/write is safer from a timing perspective than the single cycle read/write approach
- it is a bad idea to enable two tri-states driving the bus at the same time
- an SRAM does not need to be "refreshed" while a DRAM requires refresh
- an EPROM/EEPROM/FLASH cell can hold its state even if the power supply is turned off
- a synchronous memory can result in higher throughput